

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







RoHS COMPLIANT

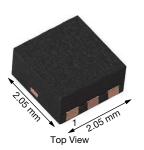


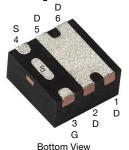
Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY									
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A) b, c	Q _g (TYP.)						
30	0.0200 at V _{GS} = 10 V	10.1	5.6						
	0.0240 at V _{GS} = 4.5 V	9.2	3.0						

PowerPAK® SC-70-6L Single



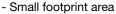


Marking Code: A L **Ordering Information:**

SiA432DJ-T1-GE3 (Lead (Pb)-free and Halogen-free) SiA432DJ-T4-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET® power MOSFET
- Thermally enhanced PowerPAK® SC-70 package

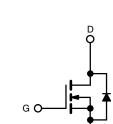


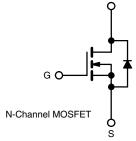


• Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

Load Switch





ABSOLUTE MAXIMUM RATING	• (1A – 20 °C, G	1	Y Company of the Comp		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		12 ^a		
O	T _C = 70 °C	1 .	12 ^a		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	10.1 ^{b, c}		
	T _A = 70 °C		8.1 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	30		
Continuous Course Drain Diade Current	T _C = 25 °C		12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S	2.9 b, c		
Single-Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15.5		
Single-Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	12	mJ	
	T _C = 25 °C		19.2		
Mayimum Dawar Dissination	T _C = 70 °C	'	12.3	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.5 b, c	VV	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperatur	re Range	T _J , T _{stg}	-55 to 150	00	
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260	°C	

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
		R_{thJA}	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	- C/VV				

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050	-	35	-	mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.6	-	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zana Onla Wallana Buria O annal		V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α
	_	V _{GS} = 10 V, I _D = 6 A	-	0.0158	0.0200	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 5 A	-	0.0190	0.0240	Ω
Forward Transconductance a	g _{fs}	V _{DS} = 10 V, I _D = 6 A	-	22	-	S
Dynamic ^b			<u> </u>		<u> </u>	
Input Capacitance	C _{iss}		-	800	_	
Output Capacitance	Coss	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	115	-	pF
Reverse Transfer Capacitance	C _{rss}		-	54	-	
	Qg	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	-	13	20	nC
Total Gate Charge			-	5.6	9	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2	-	
Gate-Drain Charge	Q _{gd}		-	1.4	-	
Gate Resistance	R _g	f = 1 MHz	-	3	-	Ω
Turn-On Delay Time	t _{d(on)}		-	15	25	-
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.9 \Omega$	-	11	17	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	15	25	
Fall Time	t _f		-	10	15	
Turn-On Delay Time	t _{d(on)}		-	8	15	ns
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.9 \Omega$	-	8	15	- - -
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	15	25	
Fall Time	t _f		-	8	15	
Drain-Source Body Diode Characteristic	es	l	l		l	l.
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	12	
Pulse Diode Forward Current			-	_	30	A
Body Diode Voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.8	1.2	V
ody Diode Reverse Recovery Time t _{rr}			-	16	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	8	15	nC
Reverse Recovery Fall Time	ta	$I_F = 8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$	-	9.8	-	ns
Reverse Recovery Rise Time	t _b	1	_	6.2	_	

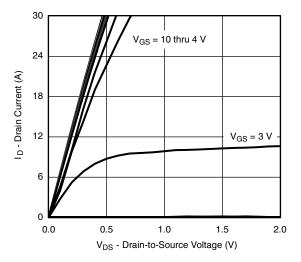
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

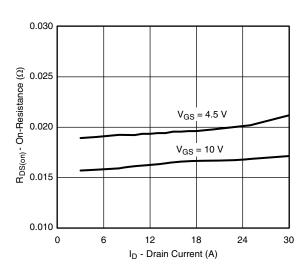
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

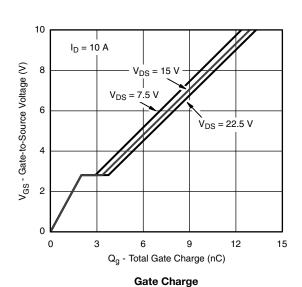




Output Characteristics



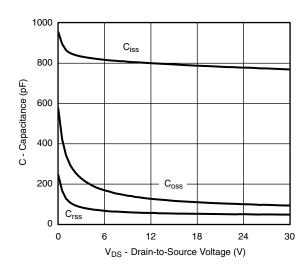
On-Resistance vs. Drain Current and Gate Voltage



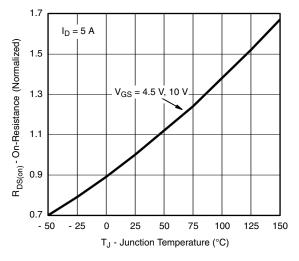
S14-0179-Rev. C, 10-Feb-14

I_D - Drain Current (A) T_C = 25 °C 3 2 1 T_C = 125 °C 55 °C 2.0 2.5 3.0 1.0 1.5

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

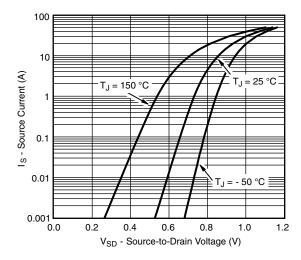


Capacitance

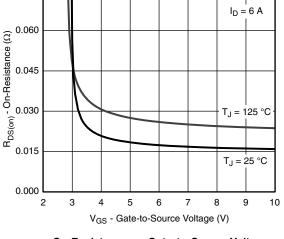


On-Resistance vs. Junction Temperature

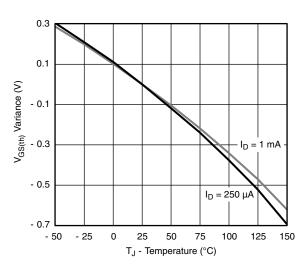




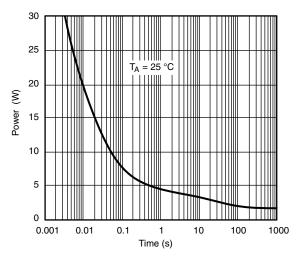
Source-Drain Diode Forward Voltage



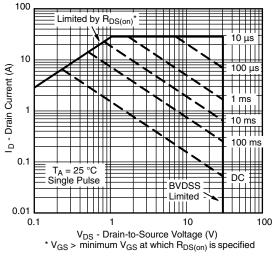
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

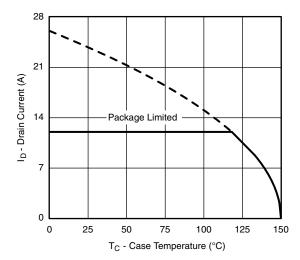


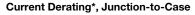
Single Pulse Power (Junction-to-Ambient)

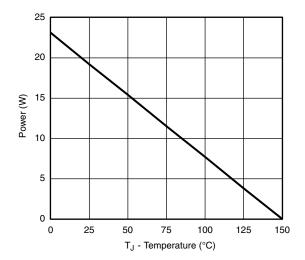


Safe Operating Area, Junction-to-Ambient





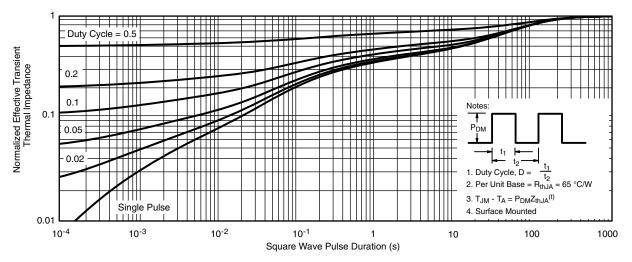




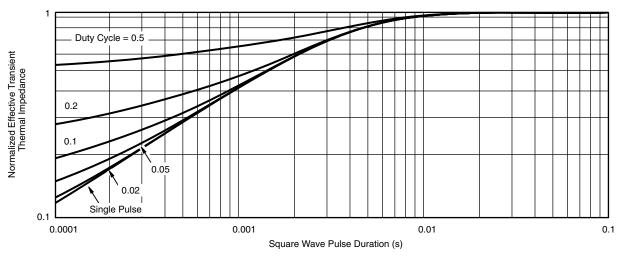
Power Derating

^{*} The power dissipation P_D is based on T_{J (max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

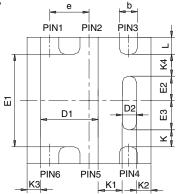
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68697.

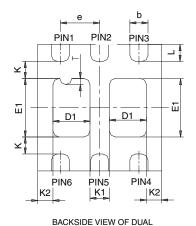




Vishay Siliconix

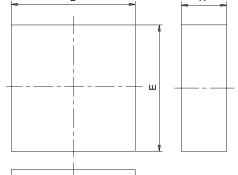
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

Α





- 1. All dimensions are in millimeters
 2. Package outline exclusive of mold flash and metal burr
 3. Package outline inclusive of plating

	SINGLE PAD						DUAL PAD						
DIM	M	ILLIMETER	RS		INCHES		M	ILLIMETER	RS		INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC			
K		0.275 TYP			0.011 TYP	l	0.275 TYP			0.011 TYP			
K1		0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP		0.009 TYP			0.252 TYP			0.010 TYP			
К3		0.225 TYP		0.009 TYP									
K4		0.355 TYP		0.014 TYP			•	•		•			
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
ECN: C-0	FCN: C-07431 – Bey C 06-Aug-07												

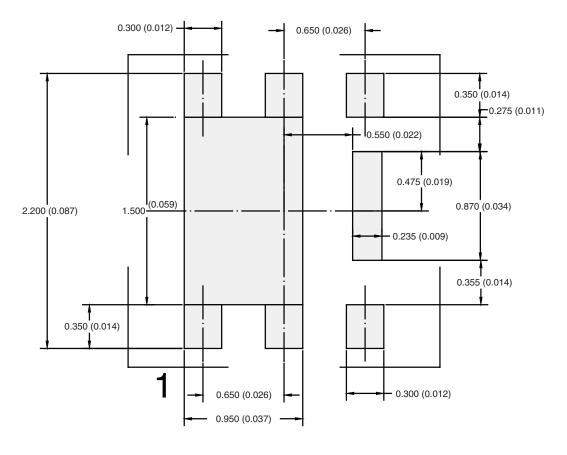
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

Return to Index

ATTLICATION NOT



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.